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Fast Rectifiers

RGF1A - RGF1M

Features

- Glass Passivated Junction
- For Surface Mounted Applications
- Low Forward Voltage Drop
- High Current Capability
- Easy Pick and Place
- High Surge Current Capability
- NRV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant



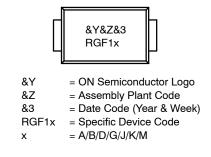
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CASE 403AE

MARKING DIAGRAM



ORDERING INFORMATION

Part Number	Top Mark	Package	Shipping [†]			
RGF1A	RGF1A	SMA	7500 / Tape & Reel			
NRVRGF1A		(Pb-Free)				
RGF1B	RGF1B SMA		7500 / Tape & Reel			
NRVRGF1B		(Pb-Free)				
RGF1D	RGF1D	SMA	7500 / Tape & Reel			
NRVRGF1D		(Pb-Free)				
RGF1G	RGF1G	SMA	7500 / Tape & Reel			
NRVRGF1G		(Pb-Free)				
RGF1J	RGF1J	SMA	7500 / Tape & Reel			
NRVRGF1J		(Pb-Free)				
RGF1K	RGF1K	SMA (Dis Franci)	7500 / Tape & Reel			
NRVRGF1K	1	(Pb-Free)				
RGF1M	RGF1M	SMA (Dis Franci)	7500 / Tape & Reel			
NRVRGF1M	1	(Pb-Free)				

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

RGF1A – RGF1M

SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^{\circ}C$ unless otherwise noted)

		Value							
Symbol	Parameter	RGF1A	RGF1B	RGF1D	RGF1G	RGF1J	RGF1K	RGF1M	Unit
V _{RRM}	Maximum Repetitive Reverse Voltage	50	100	200	400	600	800	1000	V
I _{F(AV)}	Average Rectified Forward Current at $T_L = 125^{\circ}C$	1.0							A
I _{FSM}	Non-Repetitive Peak Forward Surge Current: 8.3 ms Single Half-Sine Wave	30					A		
TJ	Operating Junction Temperature	-65 to +175						°C	
T _{STG}	Storage Temperature Range	-65 to +175					°C		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS (T_A = 25° C unless otherwise noted)

Symbol	Parameter	Value	Unit
PD	Power Dissipation	1.76	W
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance (Note 1)	85	°C/W
$R_{ hetaJL}$	Junction-to-Lead Thermal Resistance (Note 1)	28	°C/W

1. Device mounted on FR-4 PCB 0.013 mm.

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

			Value							
Symbol	Parameter	Conditions	RGF1A	RGF1B	RGF1D	RGF1G	RGF1J	RGF1K	RGF1M	Unit
V _F	Maximum Forward Voltage	I _F = 1.0 A	1.3							V
t _{rr}	Maximum Reverse Recovery Time	I _F = 0.5 A, I _R = 1.0 A, I _{RR} = 0.25 A	150 250				500		ns	
Ι _R	Maximum Reverse Current	$T_A = 25^{\circ}C$	5.0					μA		
	at Rated V _R	T _A = 125°C	100							
C _T	Typical Capacitance	V _R = 4.0 V, f = 1.0 MHz	8.5						pF	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

RGF1A - RGF1M

TYPICAL PERFORMANCE CHARACTERISTICS

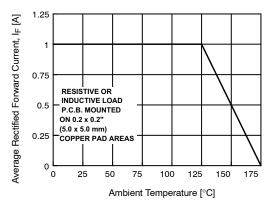


Figure 1. Forward Current Derating Curve

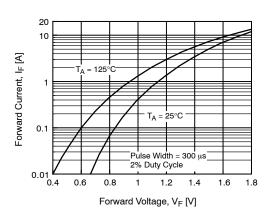


Figure 3. Forward Voltage Characteristics

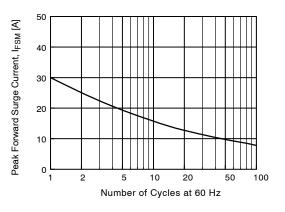


Figure 2. Non-Repetitive Surge Current

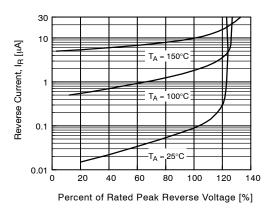


Figure 4. Reverse Current vs. Reverse Voltage

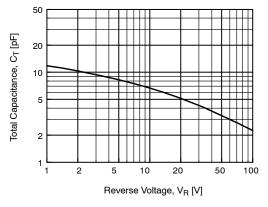


Figure 5. Total Capacitance



SMA CASE 403AE ISSUE O DATE 31 AUG 2016 5.60 \oplus 0.13 (M) В С В Α B 4.80 2.65 2.95 1.65 1.75 ́Β` 2.50 1.20 4.30 4.75 ΈB A 4.00 LAND PATTERN RECOMMENDATION **TOP VIEW** 2.50 MAX 2.20 NOTES: 1.90 A. EXCEPT WHERE NOTED, CONFORMS TO JEDEC DO214 VARIATION AC. 0.30 ∕B` DOES NOT COMPLY JEDEC STANDARD 0.203 Β 0.05 VALUE. 0.050 С C. ALL DIMENSIONS ARE IN MILLIMETERS. 2.05 D. DIMENSIONS ARE EXCLUSIVE OF **⊕**|0.13 (M) С В Α 1.95 BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS. SIDE VIEW Ε. DIMENSIONS AND TOLERANCE AS PER ASME Y14.5-2009. E. LAND PATTERN STD. DIOM5025X231M **8**° 0 R0.15 4X GAGE PLANE 0.45 0.41 0.15 1.52 **8** ° 0.75 **0** ° **DETAIL A** SCALE 20:1 Electronic versions are uncontrolled except when accessed directly from the Document Repository. DOCUMENT NUMBER: 98AON13440G Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. PAGE 1 OF 1 **DESCRIPTION:** SMA ON Semiconductor and 💷 are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding

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